

## Attestation Letter

Date: April 10, 2012

Federal Communications Commission  
Authorization and Evaluation Division

SUBJECT: ATTESTATION FOR THE MODIFICATIONS ON THE EUT  
FCC ID: RTQKSCCCBI100

To whom it may concern:

The circuit diagram and part list has been changed according to the test results. For detailed information, please refer to the followings;

| <b>CPU part modification</b> |                           |                       |
|------------------------------|---------------------------|-----------------------|
| <b>Before</b>                | <b>After</b>              | <b>Remark</b>         |
| R53(22R)                     | BF13(MMZ1005Y102C)        | Change of Component   |
| R55(22R)                     | BF14(MMZ1005Y102C)        | Change of Component   |
| BF1(HB-1S3216-121JT)         | BF1(NFM31PC276B0J3)       | Change of Component   |
| BF2(HB-1S3216-121JT)         | BF2(NFM31PC276B0J3)       | Change of Component   |
| N/A                          | TC23(10uF/16V)            | Addition of Component |
| N/A                          | C152(100nF)               | Addition of Component |
| N/A                          | BF18 ~ BF39(MMZ1005Y102C) | Addition of Component |
| N/A                          | BF15(MPZ1608S121A)        | Addition of Component |
| N/A                          | C268(10uF/16V)            | Addition of Component |
| R423(0R)                     | BF17(MPZ1608S121A)        | Change of Component   |
| R425(0R)                     | BF8(MPZ1608S121A)         | Change of Component   |
| R23(22R)                     | R23(47R)                  | Change of Component   |
| R24(22R)                     | R24(47R)                  | Change of Component   |
| R14(22R)                     | R14(100R)                 | Change of Component   |
| R15(22R)                     | R15(100R)                 | Change of Component   |
| R76(22R)                     | R76(100R)                 | Change of Component   |
| R79(22R)                     | R79(100R)                 | Change of Component   |
| R369(0R)                     | R369(100R)                | Change of Component   |
| R371(0R)                     | R371(100R)                | Change of Component   |

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| <b>SUB Main part modification</b> |   |                     |
|-----------------------------------|---|---------------------|
| <b>Before</b>                     | <b>After</b>  | <b>Remark</b>       |
| BF5(HB-1S3216-121JT)              | BF5(0R)   | Change of component |
| BF7(HB-1S3216-121JT)              | BF7(0R)   | Change of component |
|                                   | The application of Gasket to between J6(LAN port) and J13(USB port) |                     |
|                                   | The application of Gasket to between J6(LAN port) and product       |                     |
|                                   | The application of ferrite core to external USB board cable         |                     |
|                                   | Connect the Y2 case to the GND                                      |                     |
|                                   | Connect the LCD Frame GND to the SUB Main GND                       |                     |
|                                   | Connect the J16(LAN port) GND to the SUB Main GND                   |                     |
|                                   | The application of ferrite core to 40 pin FFC Cable                 |                     |
|                                   | The application of ferrite core to Debug cable                      |                     |
|                                   | The application of ferrite core to power cable                      |                     |

| <b>LCD part modification</b> |   |                     |
|------------------------------|---|---------------------|
| <b>Before</b>                | <b>After</b>  | <b>Remark</b>       |
| R105(0R)                     | R105(100R)  | Change of component |
| R106(0R)                     | R106(100R)  | Change of component |
| R107(0R)                     | R107(100R)  | Change of component |
| R108(0R)                     | R108(100R)  | Change of component |
|                              | Connect the LCD Frame GND to the Board GND                              |                     |
|                              | The application of sticking insulation tape to 40 Pin FFC cable         |                     |
|                              | The application of Gasket to between LCD Board GND and 40 Pin FFC Cable |                     |
|                              | The application of conductive tape to the 4.3' LCD on LCD board         |                     |

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| <b>Frame part modification</b> |   |               |
|--------------------------------|---|---------------|
| <b>Before</b>                  | <b>After</b>  | <b>Remark</b> |
|                                | The application of Gasket to between SUB board frame and outside case |               |

| <b>USB Board Part modification</b> |  |               |
|------------------------------------|--|---------------|
| <b>Before</b>                      | <b>After</b>                               | <b>Remark</b> |
|                                    | Reinforcement of Screw conclusion part GND |               |
|                                    | Reinforcement of Screw conclusion part GND |               |

Being the Applicant for the above mentioned FCC ID: RTQKSCCCBI100, we hereby confirm that we will apply all of the modifications listed below to the products. These modifications were made to meet the standards of the related FCC Rules & Regulations.

Sincerely,



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Infra Solution Division Leader / Henry Park  
LG CNS Co., Ltd.